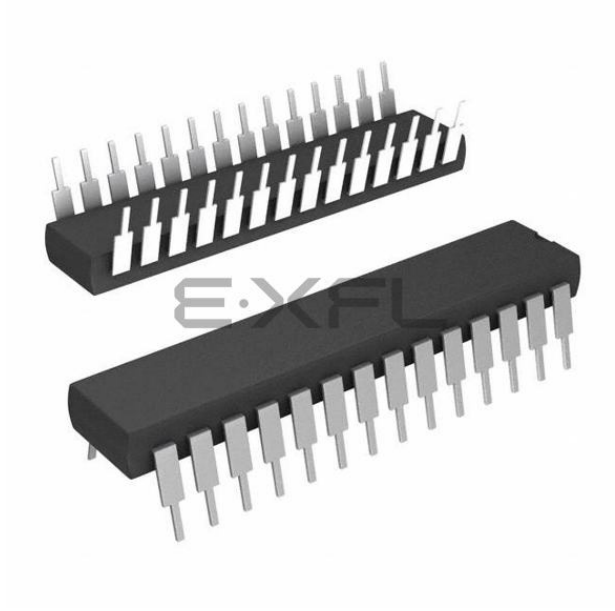

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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	dsPIC
Core Size	16-Bit
Speed	30 MIPs
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	20
Program Memory Size	24KB (8K x 24)
Program Memory Type	FLASH
EEPROM Size	1K x 8
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 5.5V
Data Converters	A/D 10x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.300", 7.62mm)
Supplier Device Package	28-SPDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/dspic30f3013-30i-sp

The core does not support a multi-stage instruction pipeline. However, a single-stage instruction prefetch mechanism is used, which accesses and partially decodes instructions a cycle ahead of execution, in order to maximize available execution time. Most instructions execute in a single cycle with certain exceptions.

The core features a vectored exception processing structure for traps and interrupts, with 62 independent vectors. The exceptions consist of up to 8 traps (of which 4 are reserved) and 54 interrupts. Each interrupt is prioritized based on a user-assigned priority between 1 and 7 (1 being the lowest priority and 7 being the highest), in conjunction with a predetermined 'natural order'. Traps have fixed priorities ranging from 8 to 15.

2.2 Programmer's Model

The programmer's model is shown in Figure 2-1 and consists of 16 x 16-bit working registers (W0 through W15), 2 x 40-bit accumulators (ACCA and ACCB), STATUS register (SR), Data Table Page register (TBLPAG), Program Space Visibility Page register (PSVPAG), DO and REPEAT registers (DOSTART, DOEND, DCOUNT and RCOUNT) and Program Counter (PC). The working registers can act as data, address or offset registers. All registers are memory mapped. W0 acts as the W register for file register addressing.

Some of these registers have a shadow register associated with each of them, as shown in Figure 2-1. The shadow register is used as a temporary holding register and can transfer its contents to or from its host register upon the occurrence of an event. None of the shadow registers are accessible directly. The following rules apply for transfer of registers into and out of shadows.

- `PUSH.S` and `POP.S`
  W0, W1, W2, W3, SR (DC, N, OV, Z and C bits only) are transferred.
- `DO` instruction
  DOSTART, DOEND, DCOUNT shadows are pushed on loop start and popped on loop end.

When a byte operation is performed on a working register, only the Least Significant Byte (LSB) of the target register is affected. However, a benefit of memory mapped working registers is that both the Least and Most Significant Bytes (MSB) can be manipulated through byte-wide data memory space accesses.

2.2.1 SOFTWARE STACK POINTER/ FRAME POINTER

The dsPIC® DSC devices contain a software stack. W15 is the dedicated Software Stack Pointer (SP), which is automatically modified by exception processing and subroutine calls and returns. However, W15 can be referenced by any instruction in the same manner as all other W registers. This simplifies the reading, writing and manipulation of the Stack Pointer (e.g., creating stack frames).

Note:	In order to protect against misaligned stack accesses, W15<0> is always clear.

W15 is initialized to 0x0800 during a Reset. The user may reprogram the SP during initialization to any location within data space.

W14 has been dedicated as a Stack Frame Pointer, as defined by the `LNK` and `ULNK` instructions. However, W14 can be referenced by any instruction in the same manner as all other W registers.

2.2.2 STATUS REGISTER

The dsPIC DSC core has a 16-bit STATUS register (SR), the LSB of which is referred to as the SR Low byte (SRL) and the MSB as the SR High byte (SRH). See Figure 2-1 for SR layout.

SRL contains all the MCU ALU operation Status flags (including the Z bit), as well as the CPU Interrupt Priority Level Status bits, IPL<2:0>, and the Repeat Active Status bit, RA. During exception processing, SRL is concatenated with the MSB of the PC to form a complete word value which is then stacked.

The upper byte of the STATUS register contains the DSP Adder/Subtracter Status bits, the DO Loop Active bit (DA) and the Digit Carry (DC) Status bit.

2.2.3 PROGRAM COUNTER

The program counter is 23 bits wide; bit 0 is always clear. Therefore, the PC can address up to 4M instruction words.

3.1.1 DATA ACCESS FROM PROGRAM MEMORY USING TABLE INSTRUCTIONS

This architecture fetches 24-bit wide program memory. Consequently, instructions are always aligned. However, as the architecture is modified Harvard, data can also be present in program space.

There are two methods by which program space can be accessed: via special table instructions, or through the remapping of a 16K word program space page into the upper half of data space (see **Section 3.1.2 "Data Access from Program Memory Using Program Space Visibility"**). The TBLRDL and TBLWTL instructions offer a direct method of reading or writing the lsw of any address within program space, without going through data space. The TBLRDH and TBLWTH instructions are the only method whereby the upper 8 bits of a program space word can be accessed as data.

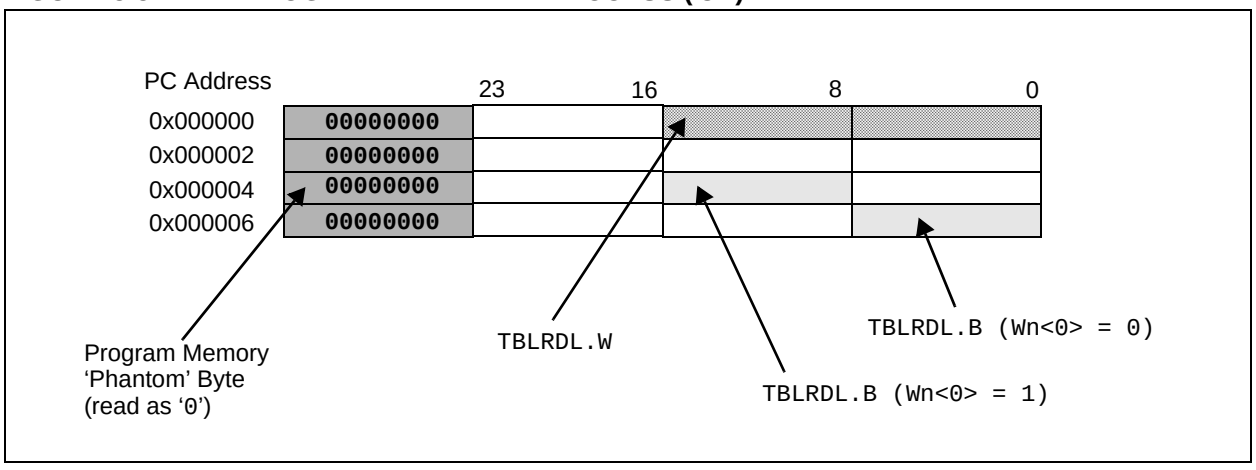
The PC is incremented by two for each successive 24-bit program word. This allows program memory addresses to directly map to data space addresses. Program memory can thus be regarded as two 16-bit word wide address spaces, residing side by side, each with the same address range. TBLRDL and TBLWTL access the space which contains the lsw, and TBLRDH and TBLWTH access the space which contains the MSB.

Figure 3-2 shows how the EA is created for table operations and data space accesses (PSV = 1). Here, P<23:0> refers to a program space word, whereas D<15:0> refers to a data space word.

A set of table instructions are provided to move byte or word-sized data to and from program space. See Figure 3-4 and Figure 3-5.

1. TBLRDL: Table Read Low
   Word: Read the LS Word of the program address; P<15:0> maps to D<15:0>.
   Byte: Read one of the LSB of the program address;
   P<7:0> maps to the destination byte when byte select = 0;
   P<15:8> maps to the destination byte when byte select = 1.
2. TBLWTL: Table Write Low (refer to **Section 5.0 "Flash Program Memory"** for details on Flash Programming)
3. TBLRDH: Table Read High
   Word: Read the MS Word of the program address; P<23:16> maps to D<7:0>; D<15:8> will always be = 0.
   Byte: Read one of the MSB of the program address;
   P<23:16> maps to the destination byte when byte select = 0;
   The destination byte will always be = 0 when byte select = 1.
4. TBLWTH: Table Write High (refer to **Section 5.0 "Flash Program Memory"** for details on Flash Programming)

FIGURE 3-3: PROGRAM DATA TABLE ACCESS (lsw)



NOTES:

7.0 I/O PORTS

Note:	This data sheet summarizes features of this group of dsPIC30F devices and is not intended to be a complete reference source. For more information on the CPU, peripherals, register descriptions and general device functionality, refer to the "*dsPIC30F Family Reference Manual*" (DS70046).

All of the device pins (except VDD, VSS, $\overline{\text{MCLR}}$ and OSC1/CLKI) are shared between the peripherals and the parallel I/O ports.

All I/O input ports feature Schmitt Trigger inputs for improved noise immunity.

7.1 Parallel I/O (PIO) Ports

When a peripheral is enabled and the peripheral is actively driving an associated pin, the use of the pin as a general purpose output pin is disabled. The I/O pin can be read, but the output driver for the parallel port bit is disabled. If a peripheral is enabled, but the peripheral is not actively driving a pin, that pin can be driven by a port.

All port pins have three registers directly associated with the operation of the port pin. The Data Direction register (TRISx) determines whether the pin is an input or an output. If the data direction bit is a '1', then the pin is an input. All port pins are defined as inputs after a Reset. Reads from the latch (LATx), read the latch. Writes to the latch, write the latch (LATx). Reads from the port (PORTx), read the port pins and writes to the port pins, write the latch (LATx).

Any bit and its associated data and Control registers that are not valid for a particular device are disabled. That means the corresponding LATx and TRISx registers and the port pin read as zeros.

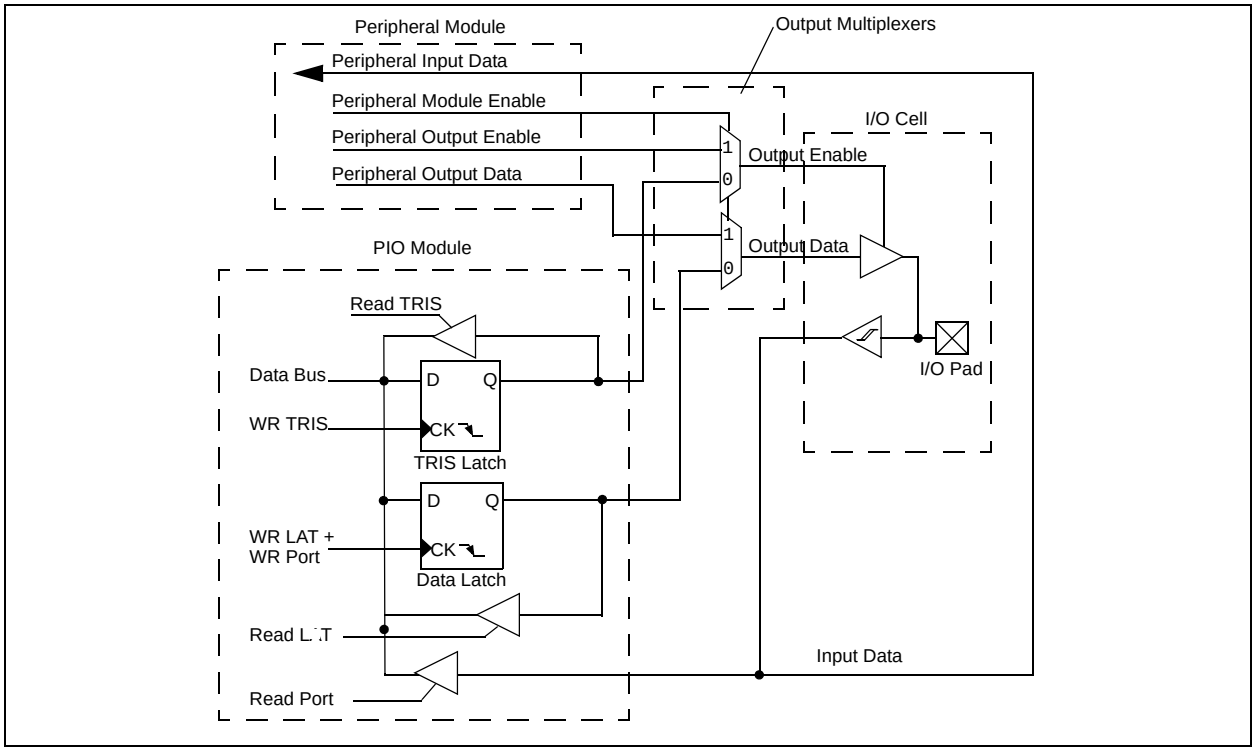
When a pin is shared with another peripheral or function that is defined as an input only, it is nevertheless regarded as a dedicated port because there is no other competing source of outputs.

A parallel I/O (PIO) port that shares a pin with a peripheral is, in general, subservient to the peripheral. The peripheral's output buffer data and control signals are provided to a pair of multiplexers. The multiplexers select whether the peripheral or the associated port has ownership of the output data and control signals of the I/O pad cell. Figure 7-1 illustrates how ports are shared with other peripherals and the associated I/O cell (pad) to which they are connected.

The format of the registers for the shared ports, (PORTB, PORTC, PORTD and PORTF) are shown in Table 7-1 through Table 7-6.

Note:	The actual bits in use vary between devices.

FIGURE 7-1: BLOCK DIAGRAM OF A SHARED PORT STRUCTURE



Enabling an interrupt is accomplished via the respective timer interrupt enable bit, T1IE. The timer interrupt enable bit is located in the IEC0 Control register in the interrupt controller.

TABLE 14-2: I²C REGISTER MAP

SFR Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset State
I2CRCV	0200	—	—	—	—	—	—	—	—	Receive Register								0000 0000 0000 0000
I2CTRN	0202	—	—	—	—	—	—	—	—	Transmit Register								0000 0000 1111 1111
I2CBRG	0204	—	—	—	—	—	—	—	Baud Rate Generator									0000 0000 0000 0000
I2CCON	0206	I2CEN	—	I2CSIDL	SCLREL	IPMIEN	A10M	DISSLW	SMEN	GCEN	STREN	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	0001 0000 0000 0000
I2CSTAT	0208	ACKSTAT	TRSTAT	—	—	—	BCL	GCSTAT	ADD10	IWCOL	I2COV	D_A	P	S	R_W	RBF	TBF	0000 0000 0000 0000
I2CADD	020A	—	—	—	—	—	—	Address Register										0000 0000 0000 0000

Legend: — = unimplemented bit, read as '0'

Note: Refer to the "*dsPIC30F Family Reference Manual*" (DS70046) for descriptions of register bit fields.

15.2 Enabling and Setting Up UART

15.2.1 ENABLING THE UART

The UART module is enabled by setting the UARTEN bit in the UxMODE register (where x = 1 or 2). Once enabled, the UxTX and UxRX pins are configured as an output and an input respectively, overriding the TRIS and LAT register bit settings for the corresponding I/O port pins. The UxTX pin is at logic '1' when no transmission is taking place.

15.2.2 DISABLING THE UART

The UART module is disabled by clearing the UARTEN bit in the UxMODE register. This is the default state after any Reset. If the UART is disabled, all I/O pins operate as port pins under the control of the LAT and TRIS bits of the corresponding port pins.

Disabling the UART module resets the buffers to empty states. Any data characters in the buffers are lost and the baud rate counter is reset.

All error and status flags associated with the UART module are reset when the module is disabled. The URXDA, OERR, FERR, PERR, UTXEN, UTXBRK and UTXBF bits are cleared, whereas RIDLE and TRMT are set. Other control bits, including ADDEN, URXISEL<1:0>, UTXISEL, as well as the UxMODE and UxBRG registers, are not affected.

Clearing the UARTEN bit while the UART is active will abort all pending transmissions and receptions and reset the module as defined above. Re-enabling the UART will restart the UART in the same configuration.

15.2.3 ALTERNATE I/O

The alternate I/O function is enabled by setting the ALTIO bit (UxMODE<10>). If ALTIO = 1, the UxATX and UxARX pins (alternate transmit and alternate receive pins, respectively) are used by the UART module instead of the UxTX and UxRX pins. If ALTIO = 0, the UxTX and UxRX pins are used by the UART module.

15.2.4 SETTING UP DATA, PARITY AND STOP BIT SELECTIONS

Control bits PDSEL<1:0> in the UxMODE register are used to select the data length and parity used in the transmission. The data length may either be 8 bits with even, odd or no parity, or 9 bits with no parity.

The STSEL bit determines whether one or two Stop bits will be used during data transmission.

The default (power-on) setting of the UART is 8 bits, no parity and 1 Stop bit (typically represented as 8, N, 1).

15.3 Transmitting Data

15.3.1 TRANSMITTING IN 8-BIT DATA MODE

The following steps must be performed to transmit 8-bit data:

1. Set up the UART:
   First, the data length, parity and number of Stop bits must be selected. Then, the transmit and receive interrupt enable and priority bits are setup in the UxMODE and UxSTA registers. Also, the appropriate baud rate value must be written to the UxBRG register.
2. Enable the UART by setting the UARTEN bit (UxMODE<15>).
3. Set the UTXEN bit (UxSTA<10>), thereby enabling a transmission.
4. Write the byte to be transmitted to the lower byte of UxTXREG. The value will be transferred to the Transmit Shift register (UxTSR) immediately and the serial bit stream will start shifting out during the next rising edge of the baud clock. Alternatively, the data byte may be written while UTXEN = 0, following which, the user may set UTXEN. This will cause the serial bit stream to begin immediately because the baud clock will start from a cleared state.
5. A transmit interrupt will be generated, depending on the value of the interrupt control bit UTXISEL (UxSTA<15>).

15.3.2 TRANSMITTING IN 9-BIT DATA MODE

The sequence of steps involved in the transmission of 9-bit data is similar to 8-bit transmission, except that a 16-bit data word (of which the upper 7 bits are always clear) must be written to the UxTXREG register.

15.3.3 TRANSMIT BUFFER (UxTXB)

The transmit buffer is 9 bits wide and 4 characters deep. Including the Transmit Shift register (UxTSR), the user effectively has a 5-deep FIFO (First-In, First- Out) buffer. The UTXBF bit (UxSTA<9>) indicates whether the transmit buffer is full.

If a user attempts to write to a full buffer, the new data will not be accepted into the FIFO and no data shift will occur within the buffer. This enables recovery from a buffer overrun condition.

The FIFO is reset during any device Reset, but is not affected when the device enters or wakes up from a Power Saving mode.

15.10 UART Operation During CPU Sleep and Idle Modes

15.10.1 UART OPERATION DURING CPU SLEEP MODE

When the device enters Sleep mode, all clock sources to the module are shut down and stay at logic ‘0’. If entry into Sleep mode occurs while a transmission is in progress, then the transmission is aborted. The UxTX pin is driven to logic ‘1’. Similarly, if entry into Sleep mode occurs while a reception is in progress, then the reception is aborted. The UxSTA, UxMODE, transmit and receive registers and buffers, and the UxBRG register are not affected by Sleep mode.

If the WAKE bit (UxMODE<7>) is set before the device enters Sleep mode, then a falling edge on the UxRX pin will generate a receive interrupt. The Receive Interrupt Select mode bit (URXISEL) has no effect for this function. If the receive interrupt is enabled, then this will wake-up the device from Sleep. The UARTEN bit must be set in order to generate a wake-up interrupt.

15.10.2 UART OPERATION DURING CPU IDLE MODE

For the UART, the USIDL bit selects if the module will stop operation when the device enters Idle mode or whether the module will continue on Idle. If USIDL = 0, the module will continue to operate during Idle mode. If USIDL = 1, the module will stop on Idle.

TABLE 16-3: A/D CONVERTER REGISTER MAP FOR dsPIC30F2012/3013

SFR Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset State
ADCBUF0	0280	—	—	—	—	ADC Data Buffer 0												0000 uuuu uuuu uuuu
ADCBUF1	0282	—	—	—	—	ADC Data Buffer 1												0000 uuuu uuuu uuuu
ADCBUF2	0284	—	—	—	—	ADC Data Buffer 2												0000 uuuu uuuu uuuu
ADCBUF3	0286	—	—	—	—	ADC Data Buffer 3												0000 uuuu uuuu uuuu
ADCBUF4	0288	—	—	—	—	ADC Data Buffer 4												0000 uuuu uuuu uuuu
ADCBUF5	028A	—	—	—	—	ADC Data Buffer 5												0000 uuuu uuuu uuuu
ADCBUF6	028C	—	—	—	—	ADC Data Buffer 6												0000 uuuu uuuu uuuu
ADCBUF7	028E	—	—	—	—	ADC Data Buffer 7												0000 uuuu uuuu uuuu
ADCBUF8	0290	—	—	—	—	ADC Data Buffer 8												0000 uuuu uuuu uuuu
ADCBUF9	0292	—	—	—	—	ADC Data Buffer 9												0000 uuuu uuuu uuuu
ADCBUFA	0294	—	—	—	—	ADC Data Buffer 10												0000 uuuu uuuu uuuu
ADCBUFB	0296	—	—	—	—	ADC Data Buffer 11												0000 uuuu uuuu uuuu
ADCBUFC	0298	—	—	—	—	ADC Data Buffer 12												0000 uuuu uuuu uuuu
ADCBUFD	029A	—	—	—	—	ADC Data Buffer 13												0000 uuuu uuuu uuuu
ADCBUFE	029C	—	—	—	—	ADC Data Buffer 14												0000 uuuu uuuu uuuu
ADCBUFF	029E	—	—	—	—	ADC Data Buffer 15												0000 uuuu uuuu uuuu
ADCON1	02A0	ADON	—	ADSIDL	—	—	—	FORM<1:0>		SSRC<2:0>			—	—	ASAM	SAMP	DONE	0000 0000 0000 0000
ADCON2	02A2	VCFG<2:0>			—	—	CSCNA	—	—	BUFS	—	SMPI<3:0>				BUFM	ALTS	0000 0000 0000 0000
ADCON3	02A4	—	—	—	SAMC<4:0>					ADRC	—	ADCS<5:0>						0000 0000 0000 0000
ADCHS	02A6	—	—	—	CH0NB	CH0SB<3:0>				—	—	—	CH0NA	CH0SA<3:0>				0000 0000 0000 0000
ADPCFG	02A8	—	—	—	—	—	—	PCFG9	PCFG8	PCFG7	PCFG6	PCFG5	PCFG4	PCFG3	PCFG2	PCFG1	PCFG0	0000 0000 0000 0000
ADCSSL	02AA	—	—	—	—	—	—	CSSL9	CSSL8	CSSL7	CSSL6	CSSL5	CSSL4	CSSL3	CSSL2	CSSL1	CSSL0	0000 0000 0000 0000

Legend: u = uninitialized bit; — = unimplemented bit, read as '0'

Note: Refer to the "*dsPIC30F Family Reference Manual*" (DS70046) for descriptions of register bit fields.

17.8 Peripheral Module Disable (PMD) Registers

The Peripheral Module Disable (PMD) registers provide a method to disable a peripheral module by stopping all clock sources supplied to that module. When a peripheral is disabled via the appropriate PMD control bit, the peripheral is in a minimum power consumption state. The Control and Status registers associated with the peripheral will also be disabled so writes to those registers will have no effect and read values will be invalid.

A peripheral module will only be enabled if both the associated bit in the PMD register is cleared and the peripheral is supported by the specific dsPIC DSC variant. If the peripheral is present in the device, it is enabled in the PMD register by default.

Note 1: If a PMD bit is set, the corresponding module is disabled after a delay of 1 instruction cycle. Similarly, if a PMD bit is cleared, the corresponding module is enabled after a delay of 1 instruction cycle (assuming the module Control registers are already configured to enable module operation).

2: In dsPIC30F2011, dsPIC30F3012 and dsPIC30F2012 devices, the U2MD bit is readable and writable and will be read as '1' when set.

17.9 In-Circuit Debugger

When MPLAB® ICD 2 is selected as a Debugger, the In-Circuit Debugging functionality is enabled. This function allows simple debugging functions when used with MPLAB IDE. When the device has this feature enabled, some of the resources are not available for general use. These resources include the first 80 bytes of Data RAM and two I/O pins.

One of four pairs of Debug I/O pins may be selected by the user using configuration options in MPLAB IDE. These pin pairs are named EMUD/EMUC, EMUD1/EMUC1, EMUD2/EMUC2 and EMUD3/EMUC3.

In each case, the selected EMUD pin is the Emulation/Debug Data line, and the EMUC pin is the Emulation/Debug Clock line. These pins will interface to the MPLAB ICD 2 module available from Microchip. The selected pair of Debug I/O pins is used by MPLAB ICD 2 to send commands and receive responses, as well as to send and receive data. To use the In-Circuit Debugger function of the device, the design must implement ICSP connections to $\overline{\text{MCLR}}$, V_{DD}, V_{SS}, PGC, PGD and the selected EMUDx/EMUCx pin pair.

This gives rise to two possibilities:

1. If EMUD/EMUC is selected as the Debug I/O pin pair, then only a 5-pin interface is required, as the EMUD and EMUC pin functions are multiplexed with the PGD and PGC pin functions in all dsPIC30F devices.
2. If EMUD1/EMUC1, EMUD2/EMUC2 or EMUD3/EMUC3 is selected as the Debug I/O pin pair, then a 7-pin interface is required, as the EMUDx/EMUCx pin functions (x = 1, 2 or 3) are not multiplexed with the PGD and PGC pin functions.

TABLE 17-7: SYSTEM INTEGRATION REGISTER MAP

SFR Name	Address	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset State
RCON	0740	TRAPR	IOPUWR	BGST	LVDEN	LVDL<3:0>				EXTR	SWR	SWDTEN	WDTO	SLEEP	IDLE	BOR	POR	(Note 1)
OSCCON	0742	—	COSC<2:0>			—	NOSC<2:0>			POST<1:0>		LOCK	—	CF	—	LPOSCEN	OSWEN	(Note 2)
OSCTUN	0744	—	—	—	—	—	—	—	—	—	—	—	—	TUN3	TUN2	TUN1	TUN0	(Note 2)
PMD1	0770	—	—	T3MD	T2MD	T1MD	—	—	—	I2CMD	U2MD(3)	U1MD	—	SPI1MD	—	—	ADCMD	0000 0000 0000 0000
PMD2	0772	—	—	—	—	—	—	IC2MD	IC1MD	—	—	—	—	—	—	OC2MD	OC1MD	0000 0000 0000 0000

Legend: — = unimplemented bit, read as '0'

Note 1: Reset state depends on type of reset.

2: Reset state depends on Configuration bits.

3: Only available on dsPIC30F3013 devices.

TABLE 17-8: DEVICE CONFIGURATION REGISTER MAP

Name	Address	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
FOSC	F80000	FCKSM<1:0>		—	—	—	FOS<2:0>			—	—	—	FPR<4:0>				
FWDT	F80002	FWDTEN	—	—	—	—	—	—	—	—	—	FWPSA<1:0>		FWPSB<3:0>			
FBORPOR	F80004	MCLREN	—	—	—	—	PWMPIN(1)	HPOL(1)	LPOL(1)	BOREN	—	BORV<1:0>		—	—	FPWRT<1:0>	
FBS	F80006	—	—	Reserved(2)		—	—	—	Reserved(2)	—	—	—	—	Reserved(2)			
FSS	F80008	—	—	Reserved(2)		—	—	Reserved(2)		—	—	—	—	Reserved(2)			
FGS	F8000A	—	—	—	—	—	—	—	—	—	—	—	—	—	Reserved(3)	GCP	GWRP
FICD	F8000C	BKBUG	COE	—	—	—	—	—	—	—	—	—	—	—	—	ICS<1:0>	

Legend: — = unimplemented bit, read as '0'

Note 1: These bits are reserved (read as '1' and must be programmed as '1').

2: Reserved bits read as '1' and must be programmed as '1'.

3: The FGS<2> bit is a read-only copy of the GCP bit (FGS<1>).

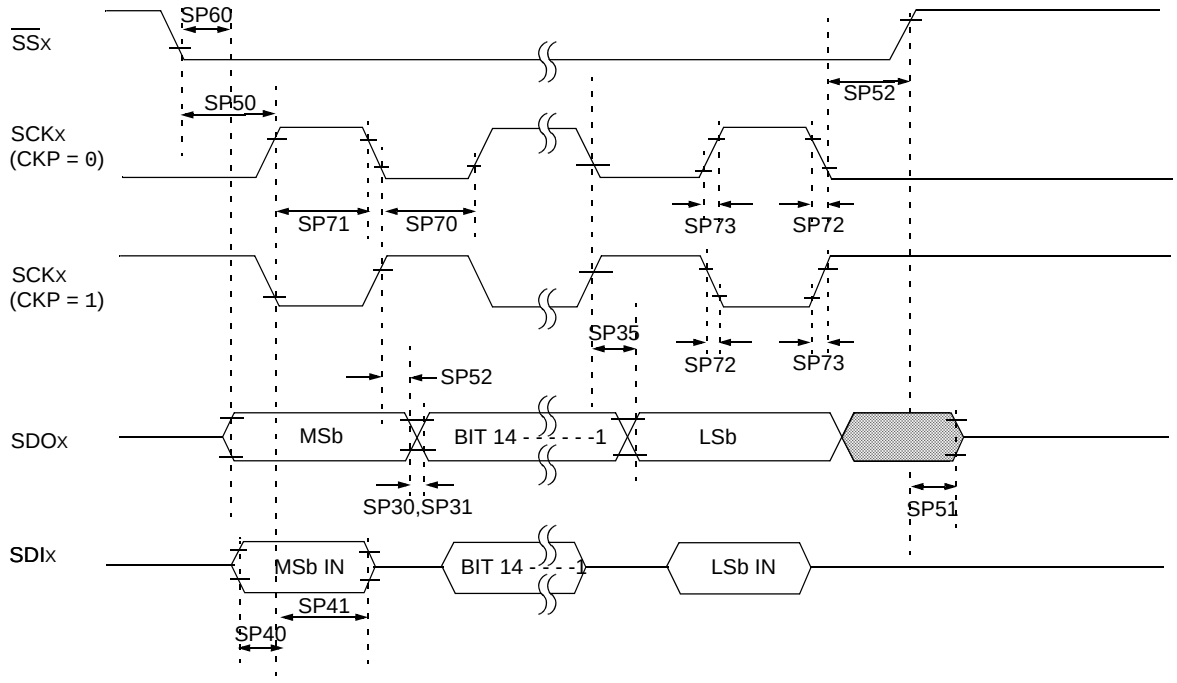
TABLE 20-5: DC CHARACTERISTICS: OPERATING CURRENT (IDD)

DC CHARACTERISTICS			Standard Operating Conditions: 2.5V to 5.5V (unless otherwise stated) Operating temperature -40°C ≤TA ≤+85°C for Industrial -40°C ≤TA ≤+125°C for Extended			
Parameter No.	**Typical(1)**	**Max**	**Units**	**Conditions**		
Operating Current (IDD)(2)						
DC31a	1.6	3.0	mA	25°C	3.3V	0.128 MIPS LPRC (512 kHz)
DC31b	1.6	3.0	mA	85°C		
DC31c	1.6	3.0	mA	125°C		
DC31e	3.6	6.0	mA	25°C	5V	
DC31f	3.3	6.0	mA	85°C		
DC31g	3.2	6.0	mA	125°C		
DC30a	3.0	5.0	mA	25°C	3.3V	(1.8 MIPS) FRC (7.37 MHz)
DC30b	3.0	5.0	mA	85°C		
DC30c	3.1	5.0	mA	125°C		
DC30e	6.0	9.0	mA	25°C	5V	
DC30f	5.8	9.0	mA	85°C		
DC30g	5.7	9.0	mA	125°C		
DC23a	9.0	15.0	mA	25°C	3.3V	4 MIPS
DC23b	10.0	15.0	mA	85°C		
DC23c	10.0	15.0	mA	125°C		
DC23e	16.0	24.0	mA	25°C	5V	
DC23f	16.0	24.0	mA	85°C		
DC23g	16.0	24.0	mA	125°C		
DC24a	22.0	33.0	mA	25°C	3.3V	10 MIPS
DC24b	22.0	33.0	mA	85°C		
DC24c	22.0	33.0	mA	125°C		
DC24e	37.0	56.0	mA	25°C	5V	
DC24f	37.0	56.0	mA	85°C		
DC24g	37.0	56.0	mA	125°C		
DC27a	41.0	60.0	mA	25°C	3.3V	20 MIPS
DC27b	40.0	60.0	mA	85°C		
DC27d	68.0	90.0	mA	25°C	5V	
DC27e	67.0	90.0	mA	85°C		
DC27f	66.0	90.0	mA	125°C		
DC29a	96.0	140.0	mA	25°C	5V	30 MIPS
DC29b	94.0	140.0	mA	85°C		

Note 1: Data in “Typical” column is at 5V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern and temperature also have an impact on the current consumption. The test conditions for all IDD measurements are as follows: OSC1 driven with external square wave from rail to rail. All I/O pins are configured as Inputs and pulled to VDD. $\overline{MCLR}$ = VDD, WDT, FSCM, LVD and BOR are disabled. CPU, SRAM, Program Memory and Data Memory are operational. No peripheral modules are operating.

FIGURE 20-15: SPI MODULE SLAVE MODE (CKE = 1) TIMING CHARACTERISTICS



Note: Refer to Figure 20-3 for load conditions.

FIGURE 20-18: I²C™ BUS START/STOP BITS TIMING CHARACTERISTICS (SLAVE MODE)

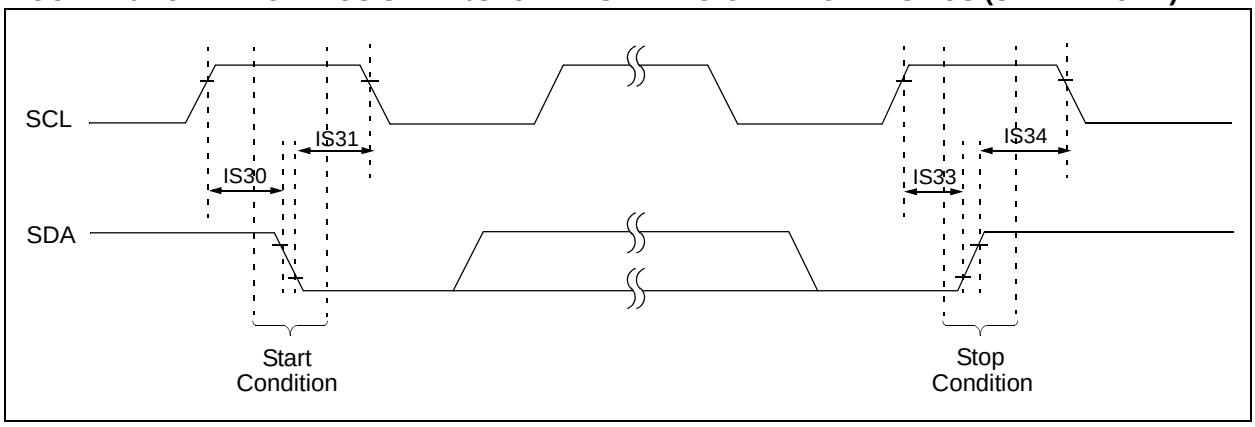


FIGURE 20-19: I²C™ BUS DATA TIMING CHARACTERISTICS (SLAVE MODE)

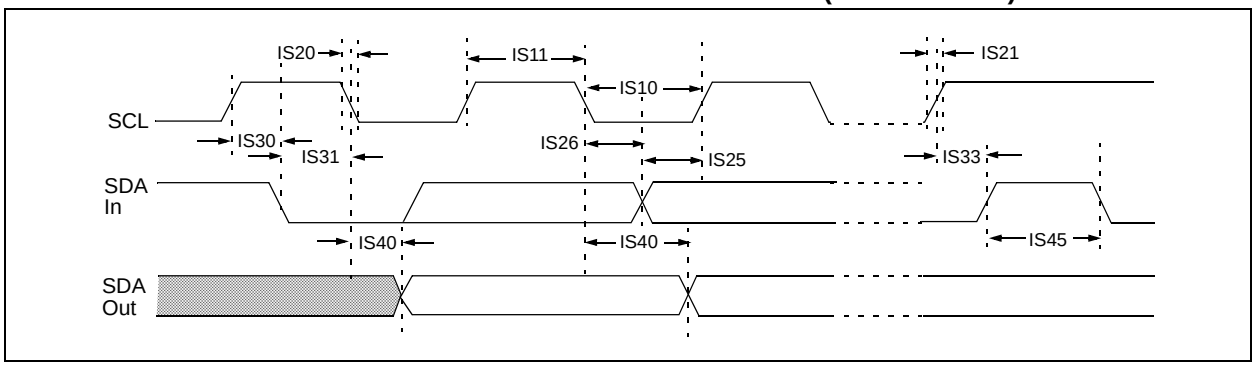


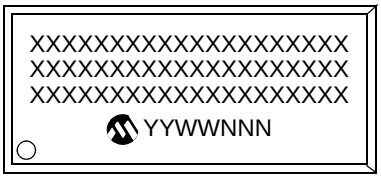
TABLE 20-34: I²C™ BUS DATA TIMING REQUIREMENTS (SLAVE MODE)

AC CHARACTERISTICS			**Standard Operating Conditions: 2.5V to 5.5V (unless otherwise stated)** Operating temperature -40°C ≤TA ≤+85°C for Industrial -40°C ≤TA ≤+125°C for Extended				
Param No.	**Symbol**	**Characteristic**		**Min**	**Max**	**Units**	**Conditions**
IS10	TLO:SCL	Clock Low Time	100 kHz mode	4.7	—	µs	Device must operate at a minimum of 1.5 MHz
			400 kHz mode	1.3	—	µs	Device must operate at a minimum of 10 MHz.
			1 MHz mode(1)	0.5	—	µs	
IS11	THI:SCL	Clock High Time	100 kHz mode	4.0	—	µs	Device must operate at a minimum of 1.5 MHz
			400 kHz mode	0.6	—	µs	Device must operate at a minimum of 10 MHz
			1 MHz mode(1)	0.5	—	µs	
IS20	TF:SCL	SDA and SCL Fall Time	100 kHz mode	—	300	ns	CB is specified to be from 10 to 400 pF
			400 kHz mode	20 + 0.1 CB	300	ns	
			1 MHz mode(1)	—	100	ns	
IS21	TR:SCL	SDA and SCL Rise Time	100 kHz mode	—	1000	ns	CB is specified to be from 10 to 400 pF
			400 kHz mode	20 + 0.1 CB	300	ns	
			1 MHz mode(1)	—	300	ns	

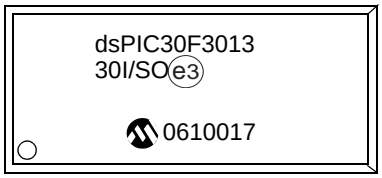
Note 1: Maximum pin capacitance = 10 pF for all I²C™ pins (for 1 MHz mode only).

21.2 Package Marking Information (Continued)

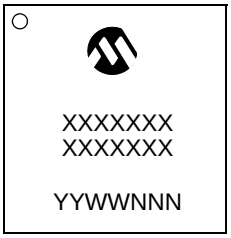
28-Lead SOIC



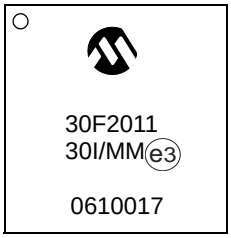
Example



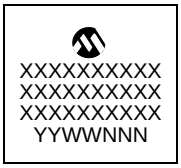
28-Lead QFN-S



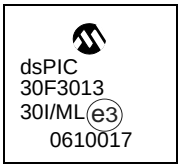
Example



44-Lead QFN

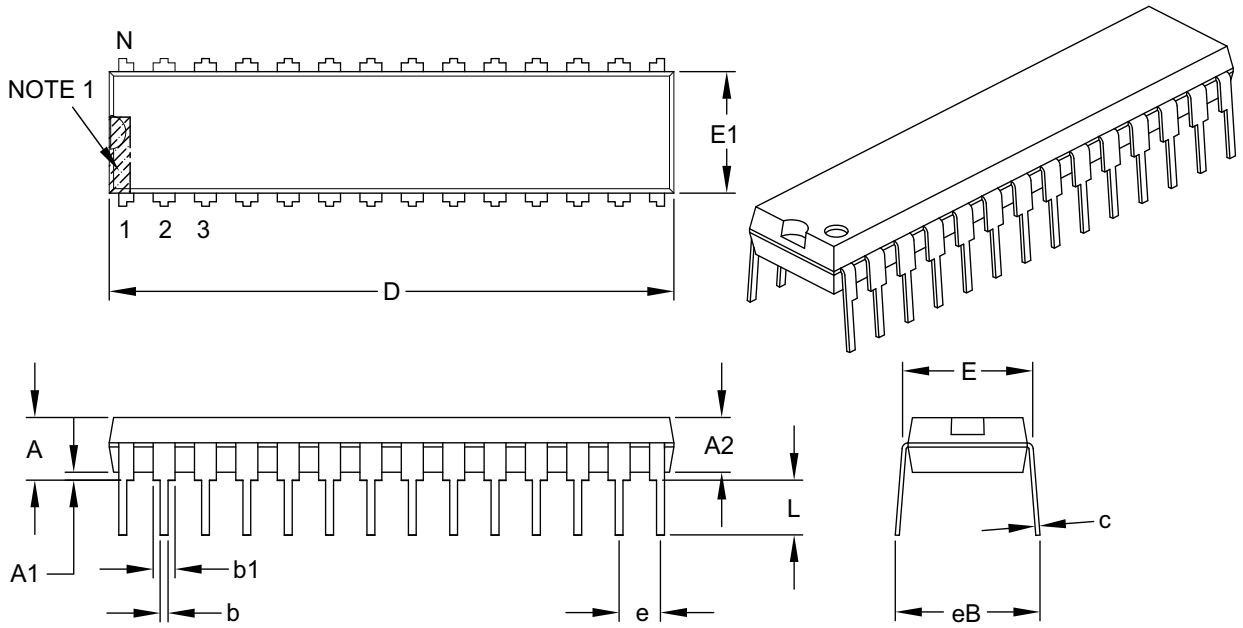


Example



28-Lead Skinny Plastic Dual In-Line (SP) – 300 mil Body [SPDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		INCHES		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		28	
Pitch	e		.100 BSC	
Top to Seating Plane	A	–	–	.200
Molded Package Thickness	A2	.120	.135	.150
Base to Seating Plane	A1	.015	–	–
Shoulder to Shoulder Width	E	.290	.310	.335
Molded Package Width	E1	.240	.285	.295
Overall Length	D	1.345	1.365	1.400
Tip to Seating Plane	L	.110	.130	.150
Lead Thickness	c	.008	.010	.015
Upper Lead Width	b1	.040	.050	.070
Lower Lead Width	b	.014	.018	.022
Overall Row Spacing §	eB	–	–	.430

Notes:

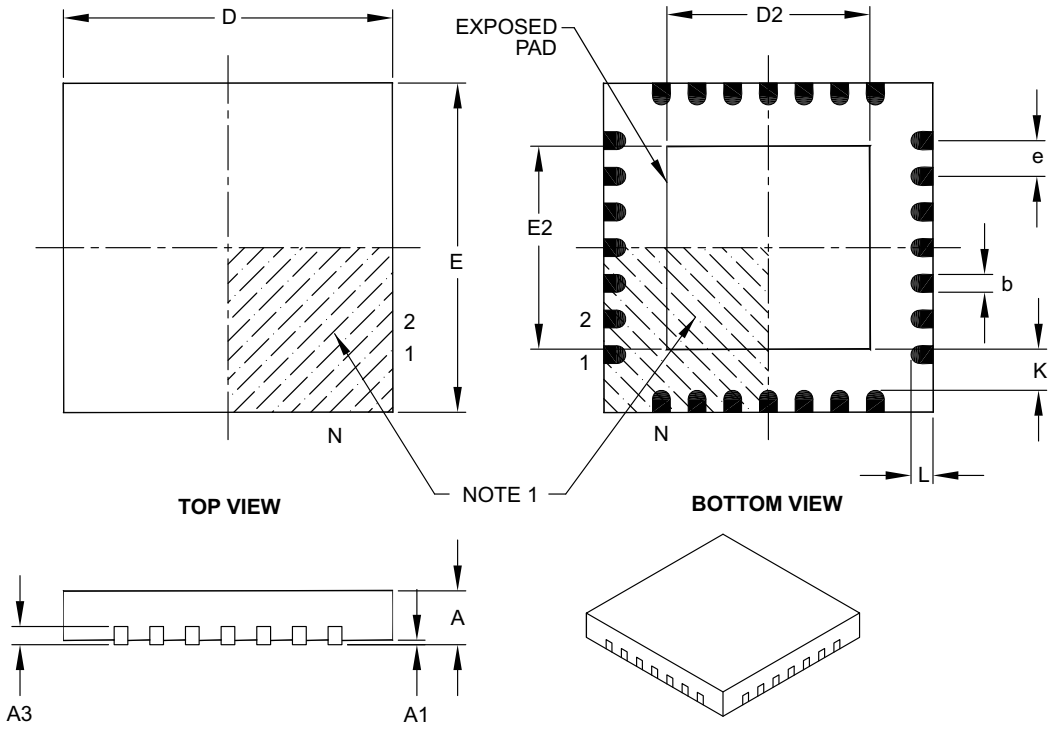
1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. § Significant Characteristic.
3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-070B

28-Lead Plastic Quad Flat, No Lead Package (MM) – 6x6x0.9 mm Body [QFN-S] with 0.40 mm Contact Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		28	
Pitch	e		0.65 BSC	
Overall Height	A	0.80	0.90	1.00
Standoff	A1	0.00	0.02	0.05
Contact Thickness	A3		0.20 REF	
Overall Width	E		6.00 BSC	
Exposed Pad Width	E2	3.65	3.70	4.70
Overall Length	D		6.00 BSC	
Exposed Pad Length	D2	3.65	3.70	4.70
Contact Width	b	0.23	0.38	0.43
Contact Length	L	0.30	0.40	0.50
Contact-to-Exposed Pad	K	0.20	–	–

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated.
3. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-124B

APPENDIX A: REVISION HISTORY

Revision D (August 2006)

Previous versions of this data sheet contained Advance or Preliminary Information. They were distributed with incomplete characterization data.

This revision reflects these updates:

- Supported I^2C Slave Addresses (see Table 14-1)
- ADC Conversion Clock selection to allow 200 kHz sampling rate (see **Section 16.0 "12-bit Analog-to-Digital Converter (ADC) Module"**)
- Operating Current (I_{DD}) Specifications (see Table 20-5)
- Idle Current (I_{IDLE}) Specifications (see Table 20-6)
- Power-Down Current (I_{PD}) Specifications (see Table 20-7)
- I/O pin Input Specifications (see Table 20-8)
- BOR voltage limits (see Table 20-11)
- Watchdog Timer time-out limits (see Table 20-21)

Revision E (December 2006)

This revision includes updates to the packaging diagrams.

Revision F (May 2008)

This revision reflects these updates:

- Added FUSE Configuration Register (FICD) details (see **Section 17.7 "Device Configuration Registers"** and Table 17-8)
- Added Note 2 to Device Configuration Registers table (Table 17-8)
- Updated Bit 10 in the UART2 Register Map (see Table 15-2). This bit is unimplemented.
- Electrical Specifications:
  - Resolved TBD values for parameters DO10, DO16, DO20, and DO26 (see Table 20-9)
  - 10-bit High-Speed ADC t_{PDU} timing parameter (time to stabilize) has been updated from 20 µs typical to 20 µs maximum (see Table 20-37)
  - Parameter OS65 (Internal RC Accuracy) has been expanded to reflect multiple Min and Max values for different temperatures (see Table 20-19)
  - Parameter DC12 (RAM Data Retention Voltage) has been updated to include a Min value (see Table 20-4)
  - Parameter D134 (Erase/Write Cycle Time) has been updated to include Min and Max values and the Typ value has been removed (see Table 20-12)
  - Removed parameters OS62 (Internal FRC Jitter) and OS64 (Internal FRC Drift) and Note 2 from AC Characteristics (see Table 20-18)
  - Parameter OS63 (Internal FRC Accuracy) has been expanded to reflect multiple Min and Max values for different temperatures (see Table 20-18)
  - Updated Min and Max values and Conditions for parameter SY11 and updated Min, Typ, and Max values and Conditions for parameter SY20 (see Table 20-21)
- Additional minor corrections throughout the document

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